AUTOMOTIVE

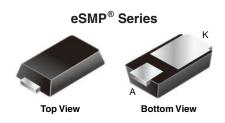
COMPLIANT

FREE



Vishay General Semiconductor

Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



MicroSMP (DO-219AD)



LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	1.0 A			
V_{RRM}	200 V			
I _{FSM}	25 A			
V _F at I _F = 1.0 A (125 °C)	0.65 V			
T _J max.	175 °C			
Package	MicroSMP (DO-219AD)			
Circuit configuration	Single			

FEATURES

- Very low profile typical height of 0.65 mm
- Trench MOS Schottky technology
- Low forward voltage drop
- · Low power loss, high efficiency
- MSL level 1, per J-STD-020,
- LF maximum peak of 260 °C • AEC-Q101 qualified available
- Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications, in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: MicroSMP (DO-219AD)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, and RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V1P22	UNIT	
Device marking code		V1D		
Maximum repetitive peak reverse voltage	V_{RRM}	200	V	
Maximum DC reverse voltage	V_{DC}	160	V	
Maximum average forward rectified current	I _{F(AV)} (1)	1.0	Α	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	25	А	
Operating junction temperature range	T _J ⁽²⁾	-40 to +175		
Storage temperature range	T _{STG}	-55 to +175	°C	

Notes

(1) Free air mounted on recommended copper pad area

(2) The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta,JA}$

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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	TEST C	TEST CONDITIONS		TYP.	MAX.	UNIT	
Instantaneous forward voltage	I _F = 0.5 A	T _A = 25 °C	V _F ⁽¹⁾	0.74	-	V	
	I _F = 1.0 A			0.80	0.88		
	I _F = 0.5 A	T _A = 125 °C		0.58	-		
	I _F = 1.0 A			0.65	0.73		
Reverse current	V _R = 160 V	T _A = 25 °C	- I _R ⁽²⁾	0.001	-	- mA	
	v _R = 100 v	T _A = 125 °C		0.1	-		
	V _R = 200 V	T _A = 25 °C		-	0.015		
	v _R = 200 v	T _A = 125 °C		0.2	1.0		
Typical junction capacitance	4.0 V, 1 MHz		CJ	50.0	-	pF	

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V1P22	UNIT	
Typical thermal resistance	R _{0JA} (1)(2)	130	°C/W	
Typical trieffial resistance	R _{θJM} ⁽³⁾	20	G/VV	

Notes

 $^{(1)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

 $^{(2)}$ Free air, mounted on recommended copper pad area; thermal resistance, $R_{\theta JA}$ - junction to ambient

 $^{(3)}$ Mounted on recommended copper pad area; thermal resistance, $R_{\theta JM}$ - junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V1P22-M3/H	0.006	Н	4500	7" diameter plastic tape and reel	
V1P22HM3/H (1)	0.006	Н	4500	7" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

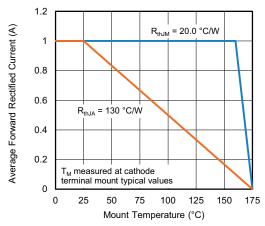
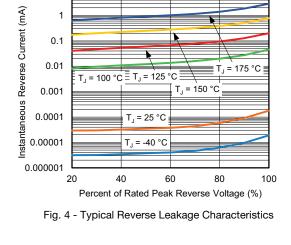


Fig. 1 - Maximum Forward Current Derating Curve



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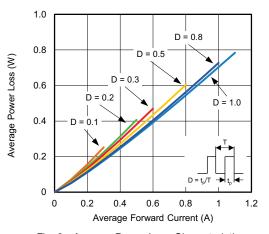


Fig. 2 - Average Power Loss Characteristics

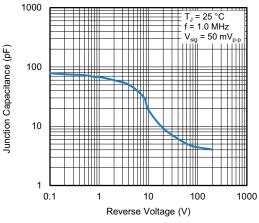


Fig. 5 - Typical Junction Capacitance

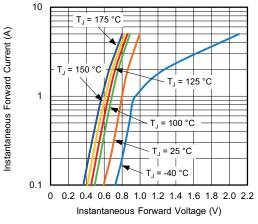


Fig. 3 - Typical Instantaneous Forward Characteristics

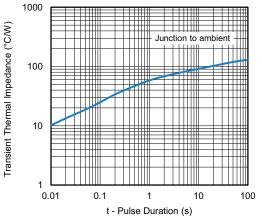


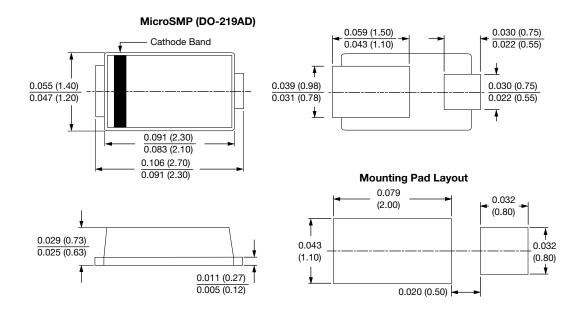
Fig. 6 - Typical Transient Thermal Impedance

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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



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